

# **STF15NM65N-STI15NM65N-STW15NM65N**

## **STB15NM65N-STP15NM65N**

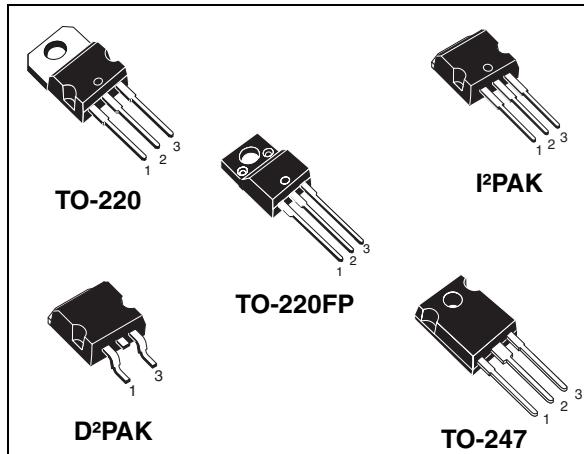
N-channel 650V - 0.25Ω - 15.5A - TO-220/FP - D<sup>2</sup>/I<sup>2</sup>PAK - TO-247  
Second generation MDmesh™ Power MOSFET

### **Features**

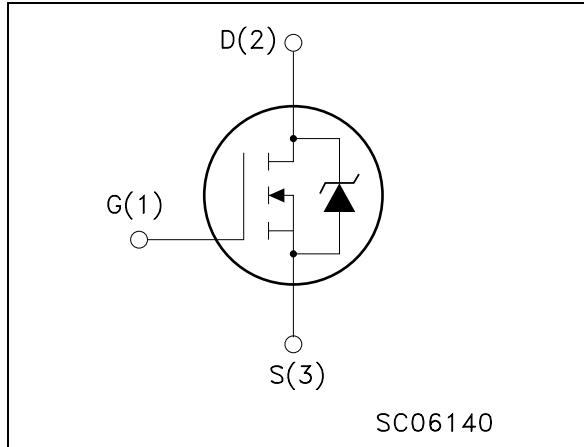
Type	V <sub>DSS</sub> (@T <sub>jmax</sub> )	R <sub>DS(on)</sub> Max	I <sub>D</sub>
STB15NM65N	710 V	< 0.27 Ω	15.5 A
STF15NM65N	710 V	< 0.27 Ω	15.5 A <sup>(1)</sup>
STI15NM65N	710 V	< 0.27 Ω	15.5 A
STP15NM65N	710 V	< 0.27 Ω	15.5 A
STW15NM65N	710 V	< 0.27 Ω	15.5 A

1. Limited only by maximum temperature allowed

- 100% avalanche tested
- Low input capacitance and gate charge
- Low gate input resistance



**Figure 1. Internal schematic diagram**



**Table 1. Device summary**

Order codes	Marking	Package	Packaging
STI15NM65N	15NM65N	I <sup>2</sup> PAK	Tube
STF15NM65N	15NM65N	TO-220FP	Tube
STP15NM65N	15NM65N	TO-220	Tube
STB15NM65NT4	15NM65N	D <sup>2</sup> PAK	Tape & reel
STW15NM65N	15NM65N	TO-247	Tube

# 1 Electrical ratings

**Table 2. Absolute maximum ratings**

Symbol	Parameter	Value		Unit
		TO-220/I <sup>2</sup> PAK D <sup>2</sup> PAK/TO-247	TO-220FP	
V <sub>DS</sub>	Drain-source voltage ( $V_{GS}=0$ )	650		V
V <sub>GS</sub>	Gate-source voltage	± 25		V
I <sub>D</sub>	Drain current (continuous) at $T_C = 25^\circ\text{C}$	15.5	15.5 <sup>(1)</sup>	A
I <sub>D</sub>	Drain current (continuous) at $T_C = 100^\circ\text{C}$	10	10 <sup>(1)</sup>	A
I <sub>DM</sub> <sup>(2)</sup>	Drain current (pulsed)	62	62 <sup>(1)</sup>	A
P <sub>TOT</sub>	Total dissipation at $T_C = 25^\circ\text{C}$	150	35	W
dv/dt <sup>(3)</sup>	Peak diode recovery voltage slope	15		V/ns
V <sub>ISO</sub>	Insulation withstand voltage (RMS) from all three leads to external heat sink ( $t=1\text{s}; T_C=25^\circ\text{C}$ )	--	2500	V
T <sub>j</sub> T <sub>stg</sub>	Operating junction temperature Storage temperature	-55 to 150		°C

1. Limited only by maximum temperature allowed
2. Pulse width limited by safe operating area
3. I<sub>SD</sub> ≤ 15.5A, di/dt ≤ 400A/μs, V<sub>DD</sub> = 80% V<sub>(BR)DSS</sub>

**Table 3. Thermal data**

Symbol	Parameter	Value		Unit
		TO-220/I <sup>2</sup> PAK D <sup>2</sup> PAK/TO-247	TO-220FP	
R <sub>thj-case</sub>	Thermal resistance junction-case Max	0.83	3.6	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-amb Max	62.5		°C/W
T <sub>I</sub>	Maximum lead temperature for soldering purpose	300		°C

**Table 4. Avalanche characteristics**

Symbol	Parameter	Max value	Unit
I <sub>AS</sub>	Avalanche current, repetitive or not-repetitive (pulse width limited by T <sub>j</sub> max)	4	A
E <sub>AS</sub>	Single pulse avalanche energy (starting T <sub>j</sub> =25 °C, I <sub>D</sub> =I <sub>AS</sub> , V <sub>DD</sub> = 50 V)	400	mJ

## 2 Electrical characteristics

( $T_{CASE}=25^{\circ}\text{C}$  unless otherwise specified)

**Table 5. On/off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$I_D = 1 \text{ mA}, V_{GS} = 0$	650			V
$dv/dt^{(1)}$	Drain source voltage slope	$V_{DD}=520 \text{ V}, I_D=15.5 \text{ A}, V_{GS}=10 \text{ V}$		30		V/ns
$I_{DSS}$	Zero gate voltage drain current ( $V_{GS} = 0$ )	$V_{DS} = \text{Max rating}$ $V_{DS} = \text{Max rating, } @125^{\circ}\text{C}$			1 100	$\mu\text{A}$ $\mu\text{A}$
$I_{GSS}$	Gate-body leakage current ( $V_{DS} = 0$ )	$V_{GS} = \pm 20 \text{ V}$			$\pm 100$	nA
$V_{GS(\text{th})}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250 \mu\text{A}$	2	3	4	V
$R_{DS(\text{on})}$	Static drain-source on resistance	$V_{GS} = 10 \text{ V}, I_D = 7.75 \text{ A}$		0.25	0.27	$\Omega$

- Characteristics value at turn off on inductive load

**Table 6. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$g_{fs}^{(1)}$	Forward transconductance	$V_{DS}=15 \text{ V}, I_D = 7.75 \text{ A}$		15		S
$C_{iss}$ $C_{oss}$ $C_{rss}$	Input capacitance Output capacitance Reverse transfer capacitance	$V_{DS} = 50 \text{ V}, f = 1 \text{ MHz}, V_{GS} = 0$		1900 110 10		pF pF pF
$C_{oss \text{ eq.}}^{(2)}$	Equivalent output capacitance	$V_{GS} = 0 \text{ V}, V_{DS} = 0 \text{ V to } 520 \text{ V}$		230		pF
$Q_g$ $Q_{gs}$ $Q_{gd}$	Total gate charge Gate-source charge Gate-drain charge	$V_{DD} = 520 \text{ V}, I_D = 15.5 \text{ A}, V_{GS} = 10 \text{ V},$		55 9 30		nC nC nC

- Pulsed: pulse duration = 300 $\mu\text{s}$ , duty cycle 1.5%
- $C_{oss \text{ eq.}}$  is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$

**Table 7. Switching times**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$t_{d(on)}$	Turn-on delay time			25		ns
$t_r$	Rise time	$V_{DD} = 325 \text{ V}$ , $I_D = 7.75 \text{ A}$		8		ns
$t_{d(off)}$	Turn-off delay time	$R_G = 4.7 \Omega$ , $V_{GS} = 10 \text{ V}$		80		ns
$t_f$	Fall time			26		ns

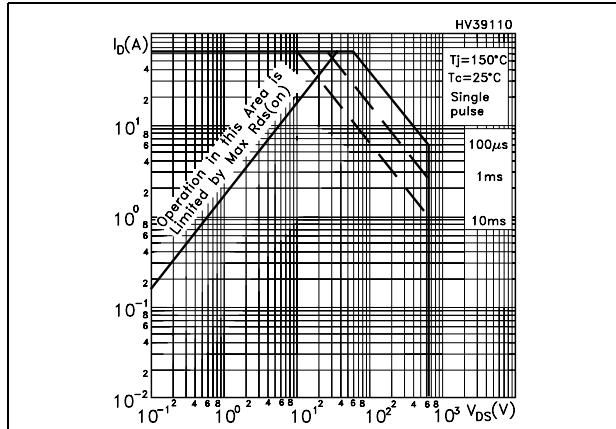
**Table 8. Source drain diode**

Symbol	Parameter	Test conditions	Min	Typ	Max	Unit
$I_{SD}$	Source-drain current				15.5	A
$I_{SDM}^{(1)}$	Source-drain current (pulsed)				62	A
$V_{SD}^{(2)}$	Forward on voltage	$I_{SD} = 15.5 \text{ A}$ , $V_{GS} = 0$			1.3	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 15.5 \text{ A}$ ,		460		ns
$Q_{rr}$	Reverse recovery charge	$di/dt = 100 \text{ A}/\mu\text{s}$		6		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current	$V_{DD} = 100 \text{ V}$ , $T_j = 25^\circ\text{C}$		27		A
$t_{rr}$	Reverse recovery time	$I_{SD} = 15.5 \text{ A}$ ,		600		ns
$Q_{rr}$	Reverse recovery charge	$di/dt = 100 \text{ A}/\mu\text{s}$		8		$\mu\text{C}$
$I_{RRM}$	Reverse recovery current	$V_{DD} = 100 \text{ V}$ , $T_j = 150^\circ\text{C}$		27		A

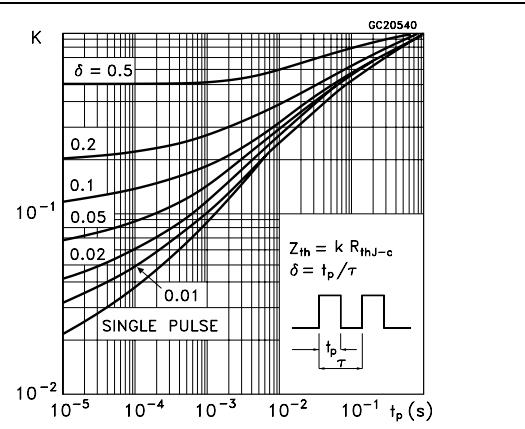
1. Pulse width limited by safe operating area
2. Pulsed: pulse duration = 300 $\mu\text{s}$ , duty cycle 1.5%

## 2.1 Electrical characteristics (curves)

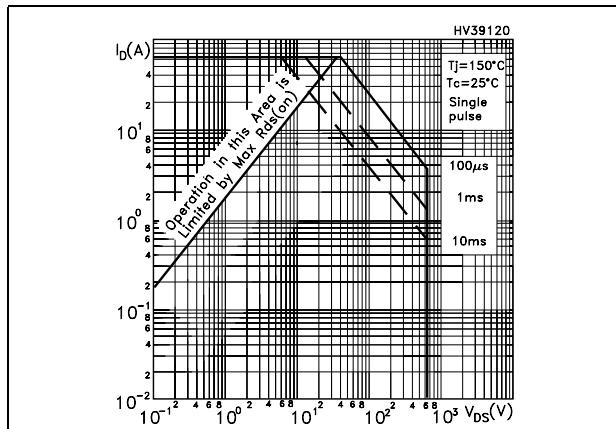
**Figure 2. Safe operating area for TO-220 - D<sup>2</sup>PAK - I<sup>2</sup>PAK**



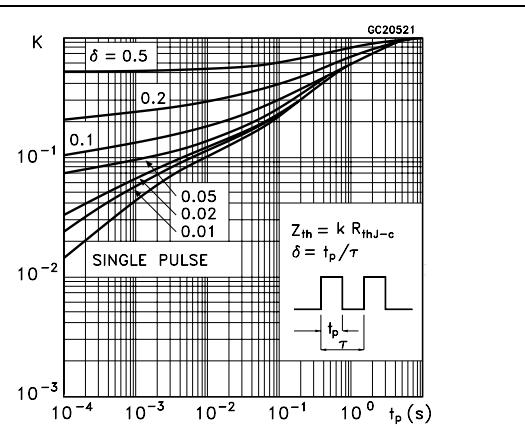
**Figure 3. Thermal impedance for TO-220 - D<sup>2</sup>PAK - I<sup>2</sup>PAK**



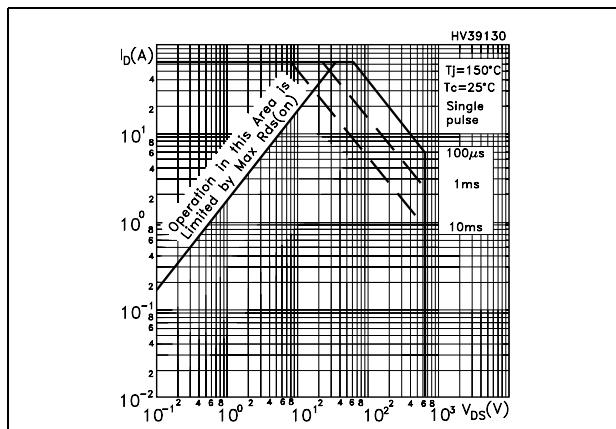
**Figure 4. Safe operating area for TO-220FP**



**Figure 5. Thermal impedance for TO-220FP**



**Figure 6. Safe operating area for TO-247**



**Figure 7. Thermal impedance for TO-247**

